THE COMMISSIONER OF PATENTS AND TRADEMARKS Washington, D.C. 20231

Sir:

Transmitted herewith for filing is the Patent Application of:

Inventor: BOR-WEN CHAN, HUAN-JUST LIN, HUN-JAN TAO

A METHOD OF FORMING A STACKED CAPACITOR STRUCTURE WITH INCREASED SURFACE AREA FOR

A DRAM DEVICE

closed are:

4 sheets of drawing(s) - formal.

An assignment of the invention to Taiwan Semiconductor Manufacturing Company

An associate power of attorney Applicant claims small entity status

Request & Certification under 35 USC 122(b)(2)(b)(i)

The filing fee has been calculated as shown below:

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FOR:	NO. FILED	NO. EXTRA	RATE	FEE
BASIC FEE	$\geq \leq$	>	><	\$ 740.
TOTAL CLAIMS	27 -20=	7	x 18 =	\$ 126.
TENDEP CLAIMS	2 -3=	0	x 84 =	\$ 0.
MULTIPLE	DEPENDENT CLA	IM PRESENTED	+ 260 =	
		st	JB TOTAL	\$ 866.
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NONPUBLICATION REQUEST UNDER 35 U.S.C. 122(b)(2)(B)(i)

First Named Inventor Bor-Wen Chan

Title Amethod of Forming a Stacked Capacitor
Structure With Increased Surface Area

Atty Docket Number TSO1-714.

I hereby certify that the invention disclosed in the attached application has not and will not be the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing.

I hereby request that the attached application not be published under 35 U.S.C. 122(b).

1/22/07 Date

Signature

Typed or printed name

This request must be signed in compliance with 37 CFR 1.33(b) and submitted with the application upon filing.

Applicant may rescind this nonpublication request at any time. If applicant rescinds a request that an application not be published under 35 U.S.C. 122(b), the application will be scheduled for publication at eighteen months from the earliest claimed filing date for which a benefit is claimed.

If applicant subsequently files an application directed to the invention disclosed in the attached application in another country, or under a multilateral international agreement, that requires publication of applications eighteen months after filing, the applicant must notify the United States Patent and Trademark Office of such filing within forty-five (45) days after the date of the filing of such foreign or international application. Failure to do so will result in abandonment of this application (35 U.S.C. 122(b)(2)(B)(iii)).

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